

Screening and outgassing modification codes MIL-DTL-38999 Series III Type

NASA and Class H Outgassing

The MIL-DTL-38999



specification defines TML and CVCM values for Class H space flight. Glenair modification code 186T provides Class H outgassing equivalency.

Additionally NASA recommends that connectors for space flight be specially screened. NASA EEE-INST-002 instructions for EEE parts selection, screening, qualification, and derating contains three levels of screening for space-grade components. These outgassing and screening modification codes are listed at right. To add a modification code append code to end of part number as shown: 233-265-H2Z117-26PN02-429C.

- **“Mission critical” connectors for space flight should undergo rigorous 100% final inspection**
- **Modification codes are available to invoke special screening for both MIL-DTL-38999 and NASA applications**
- **Outgassing properties of materials used in Glenair Series 23 SuperNine® glass-seal hermetic connectors are detailed in the table below**

| Outgassing Modification Codes | | | | |
|-------------------------------|--------------------------------|---|---|-------------------|
| Specification IAW ASTM E595 | 48 Hour Oven Bake +175° C 100% | Thermal Vacuum* Outgassing 24 Hour +125° C 100% | Thermal Vacuum* Outgassing 48 Hour +175° C 100% | Modification Code |
| ASTM E595 | | ● | | 186M |
| Class H** | | | ● | 186T |
| NASA, EEE-INST-002 | Level 3 | | ● | 429L |
| | Level 2 | | ● | 429A |
| | | ● | | 429K |
| | Level 1 | | ● | |
| ● | | | | 429J |

*Thermal vacuum of 10⁻⁶ Torr. **For Class H additional screening may be requested from NASA EEE-INST-02, Table 2A below. Screening will be added as a separate line item on the customer's purchase order.

| Commercial Part Screening Level per NASA EEE-INST-02, TABLE 2A | | | |
|--|---------|---------|---------|
| Inspection / Test | Level 1 | Level 2 | Level 3 |
| Visual | 100% | 100% | 100% |
| Mechanical | 2(0) | 2(0) | |
| DWV | 2(0) | 2(0) | |
| Insulation Resistance | 2(0) | 2(0) | |
| Contact Engagement & Separation Force | 2(0) | | |
| Hermeticity (Sealed Receptacles Only) | 100% | 100% | |
| Coupling Force | 2(0) | | |
| Mod Code 429 | | ✓ | |
| Mod Code 429B | ✓ | | |

Note: required inspection quantity and failure acceptance (0) is shown. Outgassing is required for all NASA screening levels, refer to the outgassing table for modification code.

| Outgassing Properties of Materials Used in MIL-DTL-38999 Type SuperNine Hermetic Connectors | | | | |
|---|---|-------|--------|---|
| Component | Material | TML % | CVCM % | Test Reference |
| Front and Rear Insulator | Front: high-grade rigid dielectric Rear: Epiall® | 0.84 | 0.0 | NASA Test # GSC15435 (48 hours at 180°C) |
| Grommet, Peripheral Seal and Interfacial Seal | Blended fluorosilicone/silicone elastomer | 0.04 | 0.0 | Glenair test |
| Insulator-to-Rubber Bonding Material | RTV, per MIL-A-46146 | <1.0 | <0.1 | Glenair Test |
| White Epoxy Ink for Silk-screening | Markem 7224 White | 0.49 | 0.03 | NASA Test #GSC19899 |

| MIL-DTL-38999 Type SuperNine Hermetic Connector Materials Approved for Space Flight | | |
|---|---|--------------------------------|
| Component | Material | Notes |
| Shells, Coupling Nuts, Jam Nuts | Stainless Steel | Approved for Space Flight |
| Rigid Insulators | Glass reinforced thermoset plastic, Epiall 1908 | Approved for Space Flight |
| Contact Retention Clip | Beryllium copper, heat-treated, unplated | Approved for Space Flight |
| Grommet, Peripheral Seal, Interfacial Seal, O-ring | Blended fluorosilicone/silicone elastomer | Requires outgassing processing |
| Pin/Socket Contact | Gold plated beryllium copper alloy | Approved for Space Flight |
| Socket Contact Hood | Stainless steel | Approved for Space Flight |
| Potting Compounds and Adhesives | RTV and epoxies | Requires outgassing processing |
| Hermetic Insert | Vitreous Glass | Approved for Space Flight |